

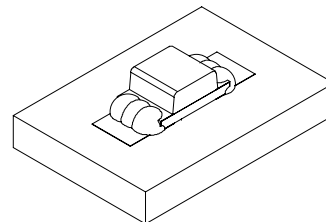
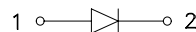
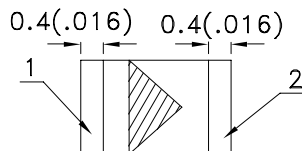
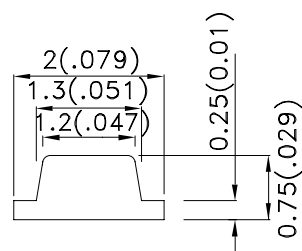
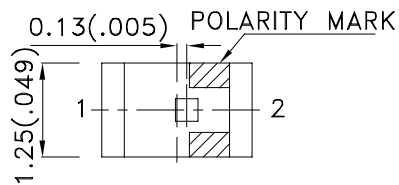
### Features

- 2.0mmx1.25mm SMT LED,0.75mm THICKNESS.
- LOW POWER CONSUMPTION.
- WIDE VIEWING ANGLE.
- IDEAL FOR BACKLIGHT AND INDICATOR.
- VARIOUS COLORS AND LENS TYPES AVAILABLE.
- PACKAGE : 2000PCS / REEL.
- MOISTURE SENSITIVITY LEVEL : LEVEL 3.
- RoHS COMPLIANT.

### Description

The Hyper Red source color devices are made with DH InGaAlP on GaAs substrate Light Emitting Diode.

### Package Dimensions



#### Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.1(0.004)$  unless otherwise noted.
3. Specifications are subject to change without notice.
4. The device has a single mounting surface. The device must be mounted according to the specifications.



## Selection Guide

| Part No.     | Dice                | Lens Type   | Iv (mcd) [2]<br>@ 20mA |      | Viewing<br>Angle<br>[1] |
|--------------|---------------------|-------------|------------------------|------|-------------------------|
|              |                     |             | Min.                   | Typ. | 2 $\theta$ 1/2          |
| APT2012SURCK | Hyper Red (InGaAlP) | WATER CLEAR | 50                     | 150  | 120°                    |

Notes:

1.  $\theta$ 1/2 is the angle from optical centerline where the luminous intensity is 1/2 the optical centerline value.
2. Luminous intensity/ luminous Flux: +/-15%.

## Electrical / Optical Characteristics at TA=25°C

| Symbol                | Parameter                | Device    | Typ. | Max. | Units | Test Conditions           |
|-----------------------|--------------------------|-----------|------|------|-------|---------------------------|
| $\lambda_{peak}$      | Peak Wavelength          | Hyper Red | 650  |      | nm    | I <sub>F</sub> =20mA      |
| $\lambda_D$ [1]       | Dominant Wavelength      | Hyper Red | 635  |      | nm    | I <sub>F</sub> =20mA      |
| $\Delta\lambda_{1/2}$ | Spectral Line Half-width | Hyper Red | 28   |      | nm    | I <sub>F</sub> =20mA      |
| C                     | Capacitance              | Hyper Red | 35   |      | pF    | V <sub>F</sub> =0V;f=1MHz |
| V <sub>F</sub> [2]    | Forward Voltage          | Hyper Red | 1.95 | 2.5  | V     | I <sub>F</sub> =20mA      |
| I <sub>R</sub>        | Reverse Current          | Hyper Red |      | 10   | uA    | V <sub>R</sub> =5V        |

Notes:

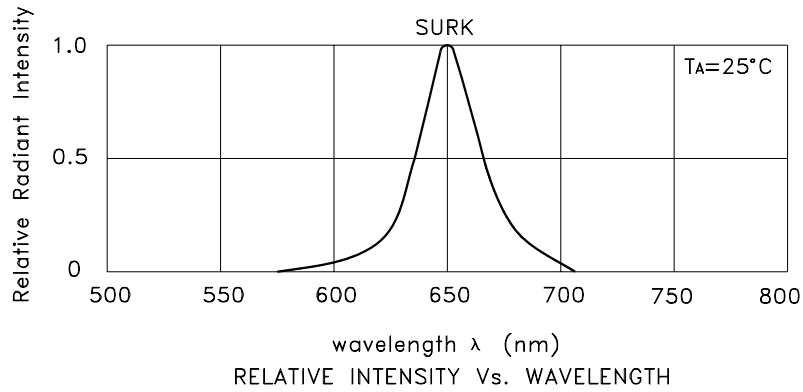
1. Wavelength: +/-1nm.
2. Forward Voltage: +/-0.1V.

## Absolute Maximum Ratings at TA=25°C

| Parameter                | Hyper Red      | Units |
|--------------------------|----------------|-------|
| Power dissipation        | 75             | mW    |
| DC Forward Current       | 30             | mA    |
| Peak Forward Current [1] | 185            | mA    |
| Reverse Voltage          | 5              | V     |
| Operating Temperature    | -40°C To +85°C |       |
| Storage Temperature      | -40°C To +85°C |       |

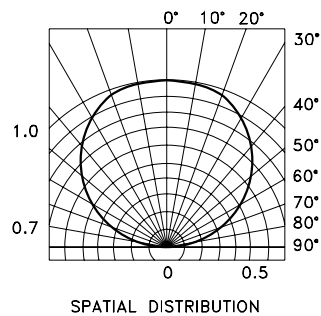
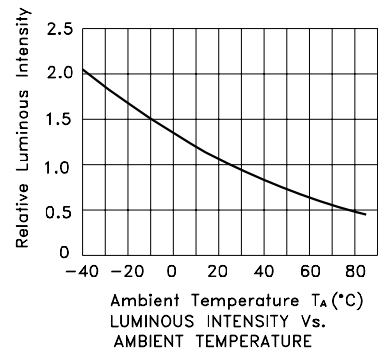
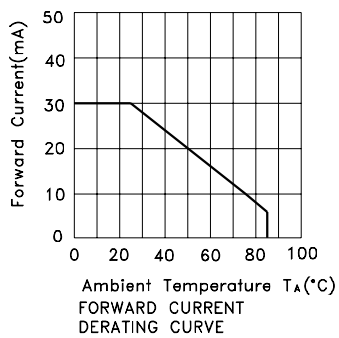
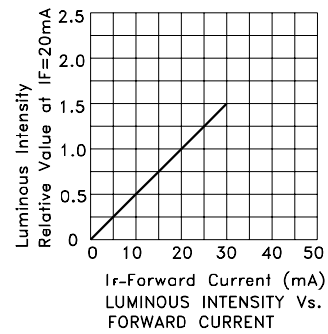
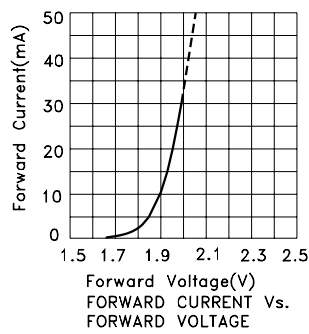
Note:

1. 1/10 Duty Cycle, 0.1ms Pulse Width.



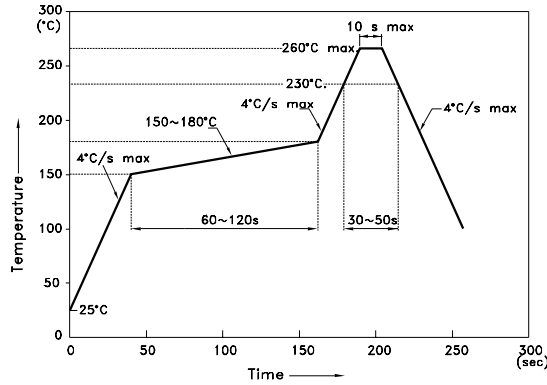
## Hyper Red

### APT2012SURCK



## APT2012SURCK

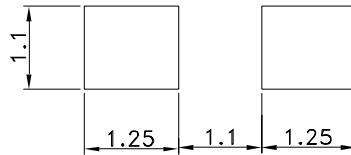
Reflow Soldering Profile For Lead-free SMT Process.



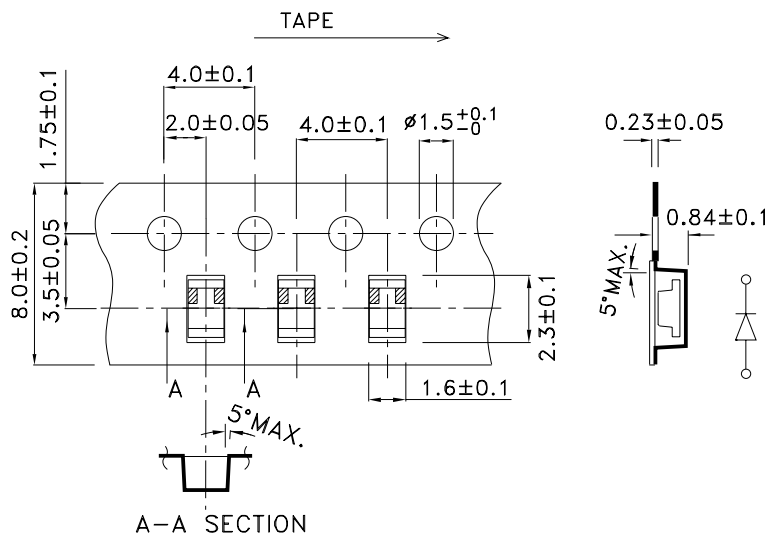
NOTES:

1. We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.
2. Don't cause stress to the epoxy resin while it is exposed to high temperature.
3. Number of reflow process shall be 2 times or less.

### Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)

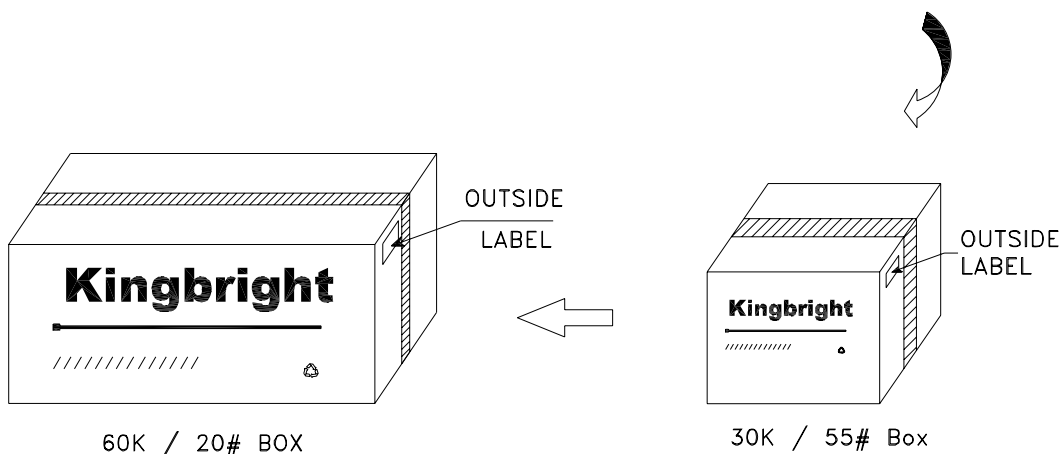
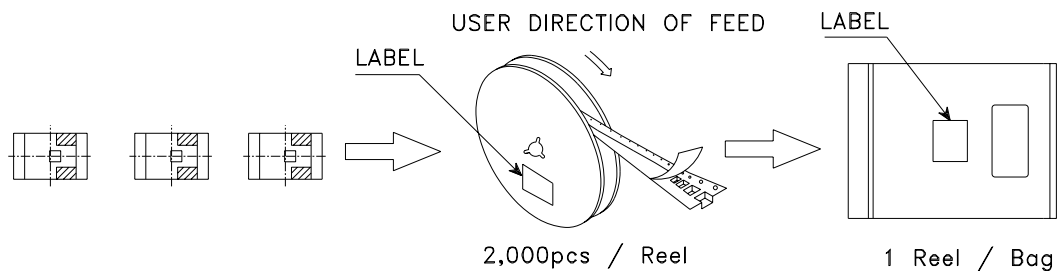



### Tape Specifications (Units : mm)



**PACKING & LABEL SPECIFICATIONS**

**APT2012SURCK**



|  |  |
|--|--|
| <b>Kingbright</b>  |  |
| P/NO: APT2012xxx   |  |
| QTY: 2,000 pcs   | Q.C. <span style="border: 1px solid black; border-radius: 50%; padding: 2px;">Q C<br/>xx xx xxxx<br/>PASSED</span> |
| S/N: XXXX  |  |
| CODE: XXX  |  |
| LOT NO:  |  |
| <br>xxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxxx |  |
| MADE IN CHINA  | RoHS Compliant   |